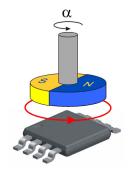


360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

Features and Benefits

- □ Absolute Rotary Position Sensor IC
- □ Tria⊗is™ Hall Technology
- □ Hi-Speed Operation
- Sine/Cosine Outputs
- ☐ Simple & Robust Magnetic Design
- Excellent Thermal Stability
- Very Low Hysteresis
- ☐ SOIC-8 Package (RoHS)



Applications

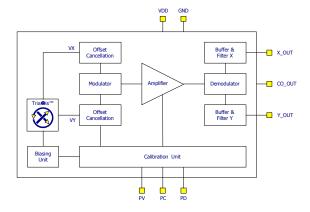
- Absolute Rotary Position Sensor
- □ BLDC Motor Position Sensor (for Commutation)
- Contactless potentiometers
- Contactless encoder



Ordering Information

Part No.	Temperature Code	Package Code	Option code
MLX91204	K (-40°C to 125°C)	DC (SOIC-8)	HF (25 V/T)
MLX91204	K (-40°C to 125°C)	DC (SOIC-8)	MF (50 V/T)

1 Functional Diagram



2 General Description

The Tria⊗is[™] rotary position sensor MLX91204 detects the absolute angular position of a small magnet that is positioned above the device surface.

The MLX91204 reports two analog, linear, orthogonal (quadrature) and ratiometric output voltages proportional to the applied magnetic flux density parallel to the chip surface (thanks to the Integrated Magneto Concentrator – IMC® – added on the top of the sensitive Hall elements).

The MLX91204 is ideally suited for hi-speed rotary position sensing in harsh automotive and industrial environments.

The angular position is computed off-chip from both sine and cosine signals.



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360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

3 Glossary of Terms

- Gauss (G), Tesla (T): Magnetic flux density units where 1 mT = 10 G.
- Tria⊗is[™]: This technology refers to the Melexis Hall technology which allows the realization of Hall effect sensors able to sense the flux density along the 3 axis (i.e. X, Y & Z). In particular, it enables the realization of position sensors able to sense the magnetic flux density parallel to the IC surface and consequently the magnetic vector over 360 degrees.
- IMC: Integrated Magneto Concentrator. It concentrates the magnetic flux lines and bends them at the extremity under the planar Hall plates. Furthermore, it provides some magnetic gain factor.

4 Absolute Maximum Ratings

Parameter.	Units
Supply Voltage, VDD (overvoltage)	+ 6 V
Reverse Voltage Protection	- 0.5 V
Operating Temperature Range TA	-40 to +125 Deg.C.
Storage Temperature Range, TS	-40 to +150 Deg.C.

Exceeding the absolute maximum ratings may cause permanent damage. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

5 Pinout and Function

Pin #	Pin Name	Function		
1	СО_оит	Output Common (VDD/2)		
2	PC	Factory programming pin. Connect to VDD		
3	VDD	Supply Voltage (+)		
4	Y_out	Analog Output Y		
5	Х_оит	Analog Output X		
6	PD	Factory programming pin. Connect to GND		
7	PV	Factory programming pin. Connect to VDD		
8	Gnd	Ground		

360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

6 MLX91204 General Electrical Specification

DC Operating Parameters TA = -40 Deg.C. to +125 Deg.C., VDD = 5.0 V (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Nominal Supply Voltage	VDD		4.5	5	5.5	V
Supply Current	Idd	IOUT = 0 mA		16.5	19	mA
Common Output	СО_оит	Referring to VDD/2, unloaded	- 2	0	2	%VDD
Output Current CO_out and X_out and Y_out	Iout	Drop is typically 80mV/mA	- 1		1	mA
Output Load Resistance	RL		5			kΩ
Output Load Capacitance	CL				1000	pF
Start-up cycle	tstartup			150	200	μs

7 MLX91204 Sensor Specification

DC Operating Parameters TA = -40 Deg.C. to 125 Deg.C., VDD = 5.0 V, differential output (unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Offset Voltage	Voq	Ta = 25 Deg.C. – B = 0 mT X_оит & Y_оит	-10	0	10	mV
Offset Temperature Drift	ΔVος/ΔΤ	B = 0mT - X_out & Y_out (1)	-0.10	0	+0.10	mV/Deg.C.
Sensitivity	S	T = 25 Deg.C. – Opt. Code HF	16	25	34	V/T
Sensitivity	5	T = 25 Deg.C. – Opt. Code MF	32	50	68	V/T
Sensitivity Temperature Drift	ΔS/[SΔT]	(1)	-0.08	-0.05	-0.01	%/Deg.C.
Sensitivity Mismatch	Sxy	Sxy = Sx/Sy	-3	0	3	%
Sensitivity Mismatch Temperature Drift	Δ(Sxy)/ΔΤ	(1)	-0.012	0	0.012	%/Deg.C.
				_		_
Phase Mismatch	∠Sx-∠Sy		-1	0	1	Degree
Hysteresis	Hyst	(1)	-20	±8	20	μΤ
Full Scale Magnetic Field Range (± 2 V Output Swing)	BFS	Option Code HF			66	mT
		Option Code MF			33	mT
Max. Output Voltage Swing	VOUTMAX	B > BFS - X_OUT &Y_OUT IOUT = 0 mA	0.25		4.75	V
Angular Speed	ω	2 poles magnet			100k	RPM
Bandwidth (-3dB) DC to	BW	$R_L > 1 M\Omega - C_L < 10 pF$		15		kHz
Spectral Noise Density	ΔBnoise				750	nT/Hz ^½

(1) Characterized



360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

From the previous table and the ageing data, the intrinsic angular linearity error (in Degree) can be derived from the individual contributions as it follows:

Toot Conditions	Dawamatawa	Output	1166	
Test Conditions	Parameters	± 1 V	± 2 V	Unit
	Offset	± 0.8	± 0.4	Degree
Room Temperature (TA = 25 Deg.C.)	Sensitivity Mismatch	± 0.84	± 0.84	Degree
	Phase Mismatch	± 1	± 1	Degree
	Total	± 2.64	± 2.24	Degree
	Offset	± 0.8	± 0.4	Degree
Temperature Range	Sensitivity Mismatch	± 0.34	± 0.34	Degree
(Ta = -40 125 Deg.C.)	Phase Mismatch	± 0.12	± 0.12	Degree
	Total	± 1.26	± 0.86	Degree
	Offset	± 0.8	± 0.4	Degree
Lifetime/Ageing (HTOL 1000 hours - 5.0 V - 150 Deg.C.)	Sensitivity Mismatch	± 0.1	± 0.1	Degree
	Phase Mismatch	± 0.1	± 0.1	Degree
5 ,	Total	± 1.00	± 0.60	Degree
O	Excl. Ageing	± 3.90	± 3.10	Degree
Overall Linearity Error	Incl. Ageing	± 4.90	± 3.70	Degree

The intrinsic linearity error refers only to the linearity error associated to the MLX91204. The linearity error associated to the magnetic and mechanical (off-axis, excentricity) design is not included and should be considered as an additional contribution.

For more information, please refer to the application note:

http://www.melexis.com/Assets/Magnet Application Note MLX90316 5221.aspx

The total error can be reduced either statically (room temperature compensation) or dynamically (continuous compensation) through the off-chip signal processing performing the angular computation i.e. $arctan(Y_OUT/X_OUT)$. The compensation is applied prior to computing the arctangent function: offset, gain and phase correction can be applied.

For more information, please refer to the application note:

http://www.melexis.com/Assets/Front-End_Calibration_of_MLX90316_5252.aspx



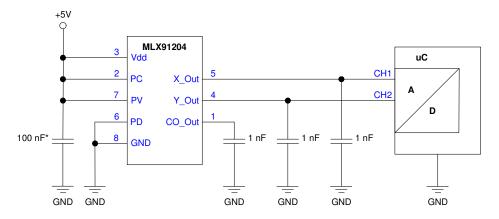
360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

8 Application Diagram

8.1 Single Ended Mode

The output voltages $X = (X_OUT - GND)$ and $Y = (Y_OUT - GND)$ are within 0.5V to 4.5V with an offset of 2.5V (VDD/2)

For reliable operation within the specifications the sensor must be connected as follows:

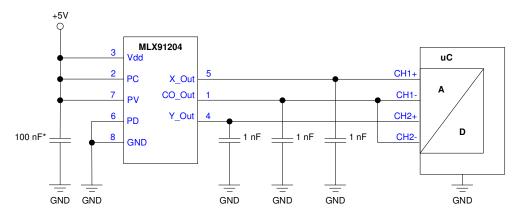


^{*} if the supply voltage is disturbed by EMI it can be useful to place a second capacitor (100 pF ceramic) parallel to the 100nF capacitor.

8.2 Differential Mode

The output voltages $X = (X_OUT - CO_OUT)$ and $Y = (Y_OUT - CO_OUT)$ are within $\pm 2 \ V$ around "virtual ground" (i.e. $CO_OUT = 2.5V = VDD/2$)

For reliable operation within the specifications the sensor must be connected as follows:



^{*} if the supply voltage is disturbed by EMI it can be useful to place a second capacitor (100pF ceramic) parallel to the 100 nF capacitor.



360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

9 Standard information regarding manufacturability of Melexis products with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

IPC/JEDEC J-STD-020

Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (Classification reflow profiles according to table 5-2) EIA/JEDEC JESD22-A113

Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (Reflow profiles according to table 2)
Melexis Working Instruction 341901308

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
 - Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat
- EIA/JEDEC JESD22-B106 and EN60749-15
 Resistance to soldering temperature for through-hole mounted devices
- Melexis Working Instruction 341901309

Iron Soldering THD's (Through Hole Devices)

- EN60749-15
 - Resistance to soldering temperature for through-hole mounted devices
- Melexis Working Instruction 341901309

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EIA/JEDEC JESD22-B102 and EN60749-21 Solderability
- Melexis Working Instruction 3304312

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

For more information on the lead free topic please see quality page at our website: http://www.melexis.com/quality.aspx



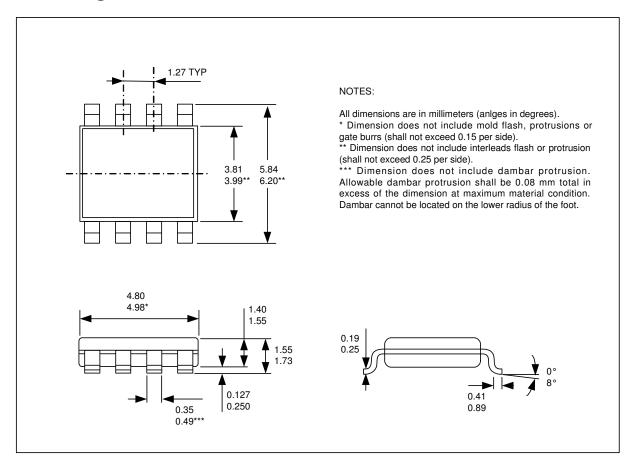
360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

10 ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD). Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

11 Package Information

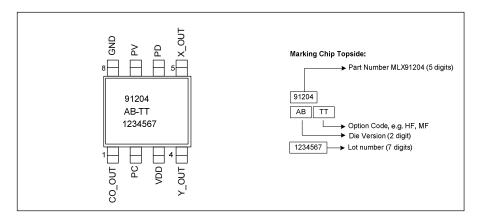
11.1 Package Dimensions

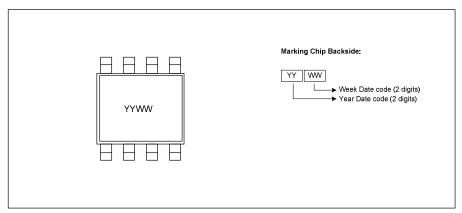




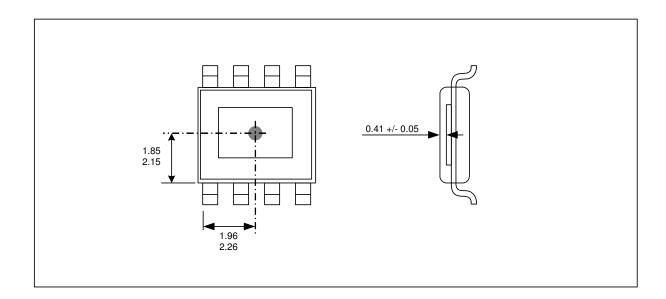
360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

11.2 Pinout and Marking





11.3 Hall Plate Positioning



Melexis Microelectronic Integrated Systems

MLX91204

360 Degrees Hi-Speed Rotary Position Sensor (Sine/Cosine)

12 Disclaimer

Devices sold by Melexis are covered by the warranty and patent indemnification provisions appearing in its Term of Sale. Melexis makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. Melexis reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with Melexis for current information. This product is intended for use in normal commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical lifesupport or life-sustaining equipment are specifically not recommended without additional processing by Melexis for each application.

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